

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3352967

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
RUEY-BIN SHEEN	03/13/2015
CHAO-CHIEH LI	03/13/2015
YING-YU HSU	05/07/2015
RECEIVING PARTY DATA	
Name:	Taiwan Semiconductor Manufacturing Company Limited
Street Address:	No. 8, Li-Hsin Road, VI
Internal Address:	Hsinchu Science Park
City:	Hsinchu
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14632013
CORRESPONDENCE DATA	
Fax Number:	(212)755-7306
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	212-326-3939
Email:	erosenfelder@JonesDay.com
Correspondent Name:	JONES DAY
Address Line 1:	222 EAST 41ST ST
Address Line 4:	NEW YORK, NEW YORK 10017
ATTORNEY DOCKET NUMBER:	181877-625163
NAME OF SUBMITTER:	MATTHEW W. JOHNSON
SIGNATURE:	/Matthew W. Johnson/
DATE SIGNED:	05/14/2015
Total Attachments: 2	
source=625163_Assignment#page1.tif	
source=625163_Assignment#page2.tif	

ASSIGNMENT

JOINT

WHEREAS, WE, RUEY-BIN SHEEN, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Taichung City, Taiwan, CHAO-CHIEH LI, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Hsinchu City, Taiwan, and YING-YU HSU, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Hsinchu City, Taiwan, ASSIGNORS, are the inventors of the invention in "SEMICONDUCTOR DEVICE FOR SIMULTANEOUS OPERATION AT TWO TEMPERATURE RANGES" for which we have executed an application for a Patent of the United States

- ☒ which is executed on ☒ even date herewith or ☐ [DATE]
☒ which is identified by Jones Day docket no. 181877-625163
☐ which was filed on _____, 2015, Application No. _____
☐ We hereby authorize and request attorney(s) at Jones Day, to insert here in parentheses (Application number _____, filed _____) the filing date and application number of said application when known.

and WHEREAS, Taiwan Semiconductor Manufacturing Company Limited, a corporation organized and existing under the laws of the Republic of China, and having an office for the transaction of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan, PROPRIETOR, is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said PROPRIETOR, its successors, legal representatives and assigns, our entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and all right to sue for infringement including past infringement.

AND WE HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said PROPRIETOR, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to the said PROPRIETOR, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said PROPRIETOR, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

Date 3/13, 2015 Ruey Bin Sheen L.S.
RUEY-BIN SHEEN

Date 3/13, 2015 Chao-Chieh Li L.S.
CHAO-CHIEH LI

Date _____, 2015 _____ L.S.
YING-YU HSU

ASSIGNMENT

JOINT

WHEREAS, WE, RUEY-BIN SHEEN, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Taichung City, Taiwan, CHAO-CHIEH LI, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Hsinchu City, Taiwan, and YING-YU HSU, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Hsinchu City, Taiwan, ASSIGNORS, are the inventors of the invention in "SEMICONDUCTOR DEVICE FOR SIMULTANEOUS OPERATION AT TWO TEMPERATURE RANGES" for which we have executed an application for a Patent of the United States

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☒ which is identified by Jones Day docket no. 181877-625163
☐ which was filed on _____, 2015, Application No. _____
☐ We hereby authorize and request attorney(s) at Jones Day, to insert here in parentheses (Application number _____, filed _____) the filing date and application number of said application when known.

and WHEREAS, Taiwan Semiconductor Manufacturing Company Limited, a corporation organized and existing under the laws of the Republic of China, and having an office for the transaction of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan, PROPRIETOR, is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said PROPRIETOR, its successors, legal representatives and assigns, our entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and all right to sue for infringement including past infringement.

AND WE HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said PROPRIETOR, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to the said PROPRIETOR, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said PROPRIETOR, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

Date _____, 2015 _____ L.S.
RUEY-BIN SHEEN

Date _____, 2015 _____ L.S.
CHAO-CHIEH LI

Date Mar. 7, 2015 Ying - Yu Hsu L.S.
YING-YU HSU